2-1717834-4 ACTIVE

Dynamic Series | Dynamic 2000 Series

TE Internal #: 2-1717834-4

Housing, Receptacle, Wire-to-Board, 8 Position, 2.5 mm [.098 in] Centerline, Crimp, 2 Row, Black, Mating Retention, Wire & Cable,

Dynamic 2000 Series

View on TE.com >



Connectors > PCB Connectors > Wire-to-Board Connectors > Wire-to-Board Connector Assemblies & Housings > Receptacle and Tab Housing: 2.5 mm Pitch, 250V











Connector Product Type: Housing

Connector & Housing Type: Receptacle

Connector System: Wire-to-Board

Number of Positions: 8

Centerline (Pitch): 2.5 mm [.098 in]

All Receptacle and Tab Housing: 2.5 mm Pitch, 250V (54)

Features

Product Type Features

	ng
Connector & Housing Type Recep	tacle
Connector System Wire-to	o-Board
Sealable	
Connector & Contact Terminates To Wire 8	k Cable

Configuration Features

Number of Positions	8
Number of Rows	2

Body Features

Primary Product Color	Black
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Termination Features



Termination Method to Wire & Cable	Crimp
Mechanical Attachment	
Mating Retention	With
Connector Mounting Type	Cable Mount (Free-Hanging)
Housing Features	
Centerline (Pitch)	2.5 mm[.098 in]
Dimensions	
Row-to-Row Spacing	3.75 mm[.147 in]
Usage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Circuit Application	Signal

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach



Compatible Parts



Also in the Series | Dynamic 2000 Series



Connector Contacts(10)



Connector Hardware(3)



Insertion & Extraction Tools(2)



PCB Headers & Receptacles(44)



PCB Terminal Blocks(23)



Wire-to-Board Connector Assemblies & Housings(54)

Customers Also Bought



TE Part #1-1903128-0 DYNAMIC 1100D TAB HSG 40P P/M



TE Part #1-1318114-6 DYNAMIC D-2100 TAB HSG 12P P/M



18 wire size, gold plated













Documents

Product Drawings

DYNAMIC 2000 REC HSG 8P Y KEY WITH CUTTI

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2-1717834-4_G.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2-1717834-4_G.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2-1717834-4_G.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Dynamic Connector D-2000 Series

Japanese

Application Specification

Japanese